

Welcome to **E-XFL.COM**

Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	6100
Total RAM Bits	94208
Number of I/O	147
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfecp6e-5q208c

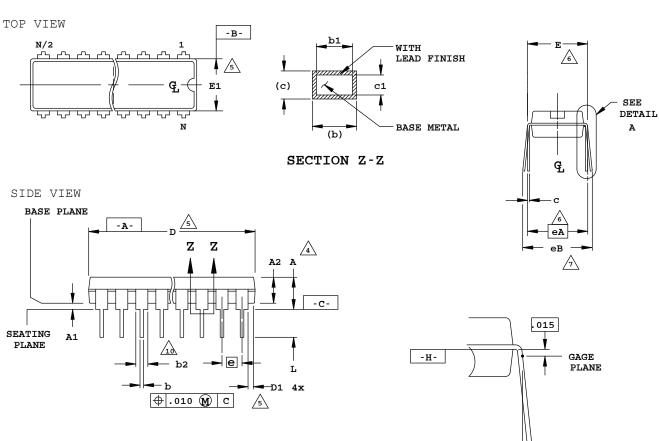
Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



24-Pin Plastic DIP

Dimensions in Inches



NOTES:

- 1. CONTROLLING DIMENSION: INCH.
- 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M
- 3. DISTANCE BETWEEN LEADS INCLUDING DAMBAR
- PROTRUSIONS TO BE .005 MINIMUM. 4 DIMENSIONS A, A1 & L ARE MEASURED WITH
- THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.

DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010

- 6 E AND eA MEASURED WITH THE LEADS CONSTRAINED
- TO BE PERPENDICULAR TO DATUM -CeB AND eC ARE MEASURED AT THE LEAD TIPS
 with the LEADS UNCONSTRAINED.
- 8 N IS THE MAXIMUM NUMBER OF LEAD POSITIONS.
- 9. POINTED OR ROUNDED LEAD TIPS ARE PREFERRED TO EASE INSERTION
- 10 b2 MAXIMUM DIMENSIONS DOES NOT INCLUDE DAMBAR PROTRUSIONS. DAMBAR PROTRUSIONS SHALL NOT EXCEED .010
- 11. DATUM PLANE -H- COINCIDENT WITH THE BOTTOM OF LEAD , WHERE LEAD EXITS BODY

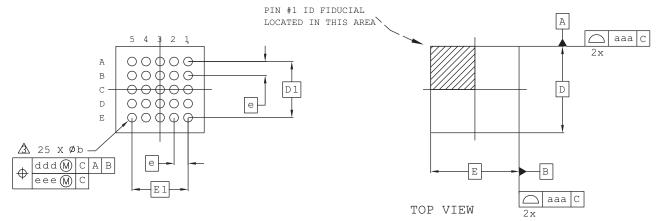
DETAIL A

	N = 24			
s Y M	I	NCHES		
В 0				N T
L	MIN.	NOM.	MAX.	E
Α	-	-	.210	4
A1	.015	-	-	4
A 2	.115	.130	.195	
b	.014	.018	.022	
b1	.014	.018	.020	
b2	.045	.060	.070	10
С	.008	.010	.014	
c1	.008	.010	.011	
D	1.230	1.250	1.280	5
D1	.005	-	-	5
E	.300	.310	.325	6
E1	.240	.250	.280	5
е	.100 BSC			
eА	.300 BSC			6
еВ	-	-	.430	7
еC	.000	-	.060	7
L	.115	.130	.150	

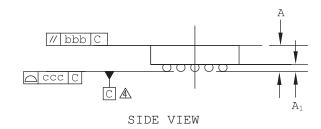


25-Ball WLCS Package (0.40 mm Pitch)

Dimensions in Millimeters



BOTTOM VIEW



Notes:

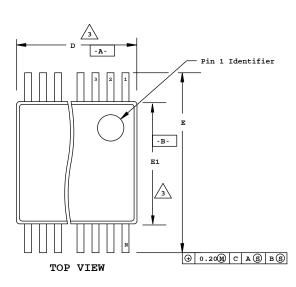
- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- △ DIMENSION "b" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM C.
- A PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

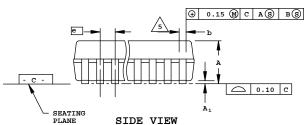
REF.	Min.	Nom.	Max.
А	0.535	0.575	0.615
A1	0.170	0.200	0.230
b	0.220	0.250	0.280
D	2	.492 BS	SC
E	2.546 BSC		
D1	1.60 BSC		
E1	1	.60 BSC	
е	0	.40 BSC	
aaa	0.025		
bbb	0.060		
ccc	0.015		
ddd	0	.150	
eee	0	.050	

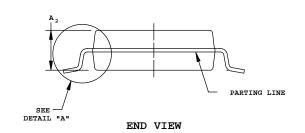


28-Pin SSOP Package

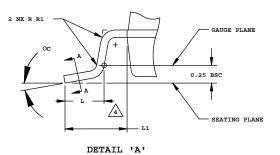
Dimensions in Millimeters

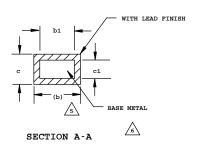






S Y	COMMON			
M B	DIMENSIONS			
O L	MIN.	NOM.	MAX.	
A			2.0	
A	0.05			
A ₂	1.65	1.75	1.85	
b	0.22	-	0.38	
b ₁	0.22	0.30	0.33	
С	0.09		0.25	
Cı	0.09	0.15	0.21	
D	9.90	10.20	10.50	
E1	5.00	5.30	5.60	
е	0.65 BSC			
Е	7.40	7.80	8.20	
L	0.55	0.75	0.95	
L1	1.25 REF.			
N		28		
oc	0	4	8	
R1	0.09			





NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETERS.
- 2. DIMENSIONING & TOLERANCES PER ANSI.Y14.5M-1982.

"D" & "E1" DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DO INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.20mm PER SIDE.

4. TO BE DETERMINED AT THE SEATING PLANE

DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION.
ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13mm TOTAL IN
EXCESS OF b DIMENSION AT MAXIMUM MATERIAL CONDITION.
DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION b BY MORE
THAN 0.07mm AT LEAST MATERIAL CONDITION.

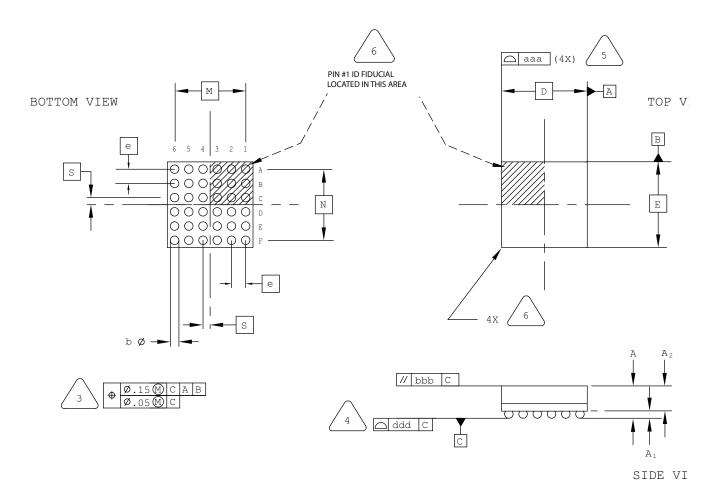
THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 & 0.25mm FROM THE LEAD TIP

7. "N" IS THE NUMBER OF TERMINAL POSITIONS



36-Ball ucBGA Package Option 1

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM $\fbox{\colored{C}}$



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

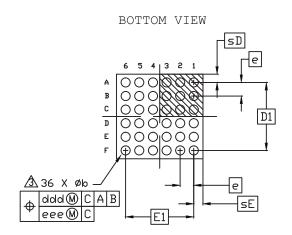


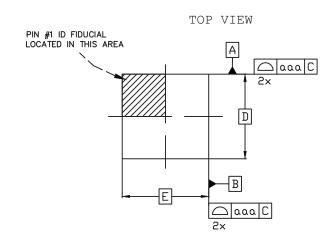
SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.00
A1	0.10	-	-
A2	ı	-	0.90
D/E	2.50 BSC		
M/N	2.00 BSC		
S	0	.20 BSC	
b	0.20	0.25	0.30
е	0.40 BSC		
aaa	-	- -	
bbb	_	_	0.10
ddd	_	_	0.10

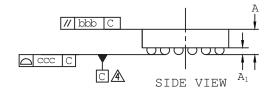


36-Ball WLCS Package Option 2: MachXO3[™]

Dimensions in Millimeters







NOTES:

- 1. ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- △ DIMENSION "b" IS MEASURES AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM [C].
- \triangle PRIMARY DATUM $\boxed{\text{C}}$ AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

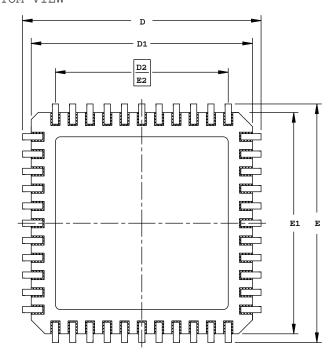
REF.	Min.	Nom.	Max.
A	0.510	0.543	0.576
A1	0.167	0.196	0.225
b	0.239	0.266	0.319
D	2.487 BSC		
E	2.541 BSC		
D1	2.00 BSC		
E1		2.00 BSC	;
е	(0.40 BSC	!
sD	-	0.244	1
sE	- 0.271 -		
aaa	0.025		
bbb	0.060		
ccc	0.030		
ddd		0.0150	
eee		0.050	

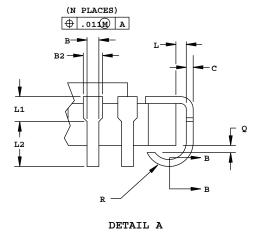


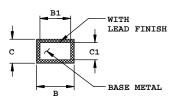
44-Pin JLCC Package

Dimensions in Inches

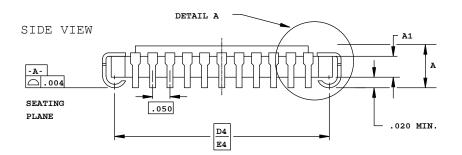
BOTTOM VIEW







SECTION B-B



NOTES:

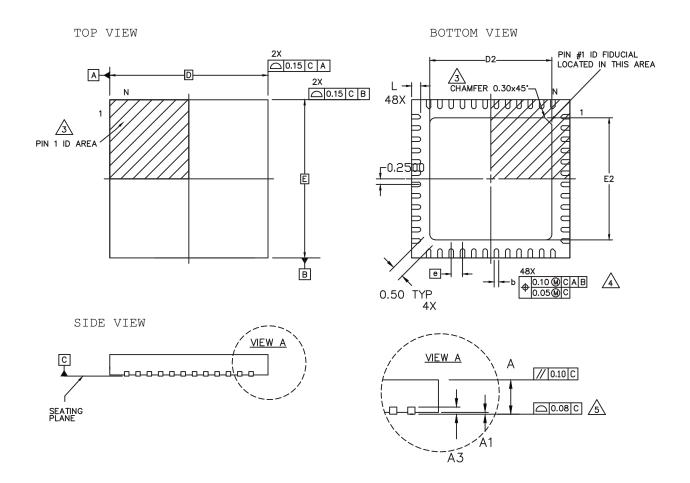
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- 3. CORNER CHAMFERS AND/OR NOTCHES ARE OPTIONAL.

S Y M	INCHES		
M B O L	MIN.		MAX.
A	.115	1	.190
A1	. 0	65 RE	F
В	.013	-	.023
B1	.013	ı	.020
B2	.022	-	.035
С	.007	ı	.013
C1	.007	ı	.010
D/E	.675	.690	.700
D1/E1	.620	ı	.660
D2/E2	.500 BSC		
D4/E4	.630 BSC		
L	.005	ı	-
L1	.020	-	-
L2	.025	1	-
Q	.003	-	-
R	.020	-	.040
N		44	



48-Pin QFN Package Option 2: L-ASC10, iCE40 Ultra, iCE40 UltraPlus, MachXO2

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

<u>3</u>

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

4

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

/5\

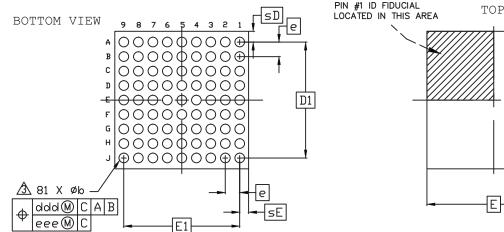
APPLIES TO EXPOSED PORTION OF TERMINALS.

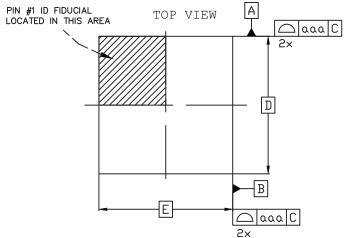
SYMBOL	MIN.	NOM.	MAX.
А	0.80	0.90	1.00
A1	0.00	0.02	0.05
A3	0.2 REF		
D		7.0 BSC	
D2	5.30	5.40	5.50
E		7.0 BSC	
E2	5.30	5.40	5.50
b	0.15	0.20	0.25
е		0.50 BSC	
L	0.35	0.40	0.45

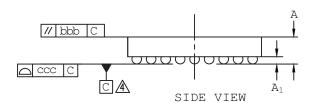


81-Ball WLCS Package

Dimensions in Millimeters







Notes:

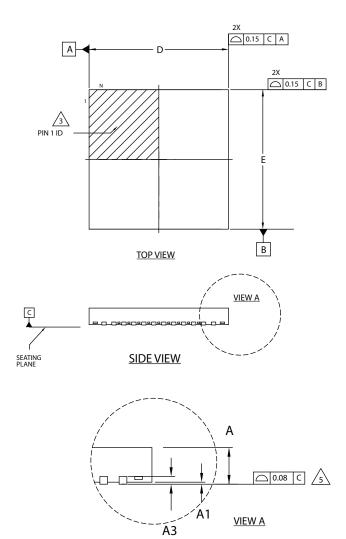
- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- \triangle DIMENSION "b" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM $\boxed{\mathbb{C}}$.
- A PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

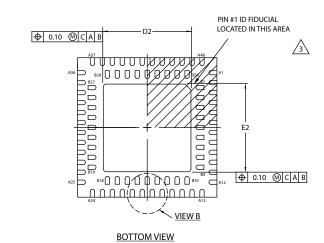
REF.	Min.	Nom.	Max.
A	0.510	0.543	0.567
A1	0.167	0.196	0.225
b	0.239	0.266	0.319
D	3	.797 BS	С
E	3	.693 BS	С
D1	3.20 BSC		
E1	3.20 BSC		
е	0	.40 BS0	2
sD	_	0.299	_
sE	_	0.247	-
aaa	0.025		
bbb	0.060		
ccc	0.030		
ddd		0.015	
eee		0.050	

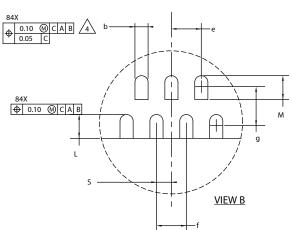


84-Pin QFN Package

Dimensions in Millimeters







SYMBOL MIN. NOM. MAX. 0.75 0.95 0.85 Α1 0.00 0.02 0.05 АЗ 0.15 REF D 7.0 BSC D2 4.50 Ε 7.0 BSC E2 4.30 4.50 0.17 0.27 b 0.22 0.50 BSC f 0.50 BSC g 0.65 BSC S 0.25 BSC $_{\rm L}$ 0.30 0.40 0.50 Μ 0.30 0.50 0.40

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{3}$

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.



DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

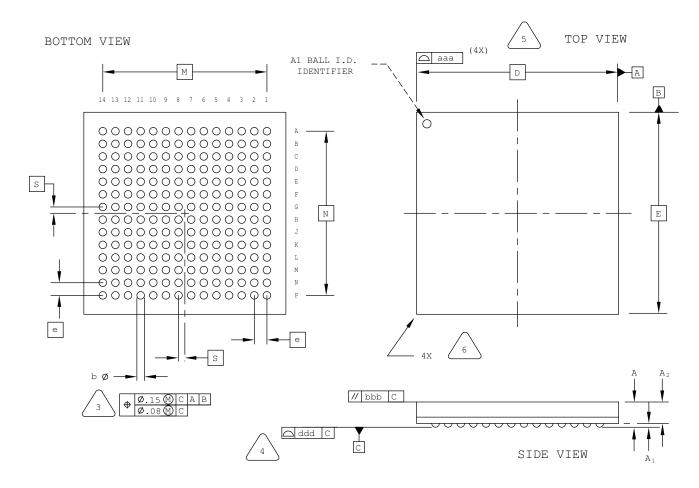


APPLIES TO EXPOSED PORTION OF TERMINALS.



196-Ball csBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

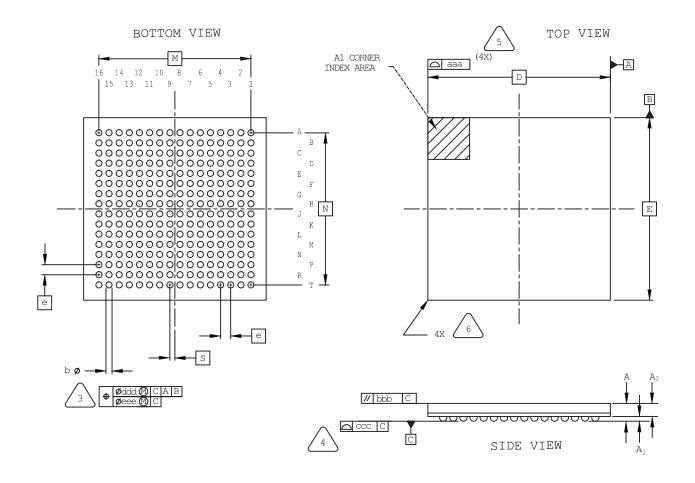


SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.00
A1	0.15	_	_
A2	_	_	0.85
D/E	8.00 BSC		
M/N	6.50 BSC		
S	0.25 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa			0.10
bbb	_	_	0.10
ddd	_	_	0.08



256-Ball csfBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM $\boxed{\mathbb{C}}$.



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

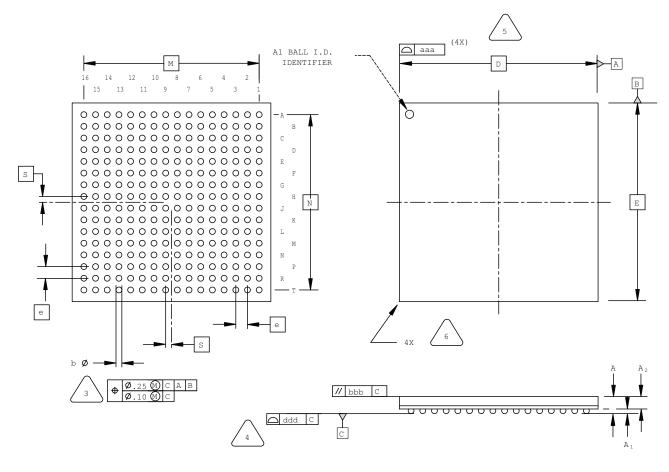


SYMBOL	MIN.	NOM.	MAX.	
А	-	-	1.00	
A1	0.15	0.24	_	
A2	ı	0.66	-	
D/E		9.00 BSC		
M/N	7.50 BSC			
S	0.25 BSC			
b	0.25	0.30	0.35	
е		0.50 BSC		
aaa	0.10			
bbb	0.10			
ccc	0.08			
ddd		0.15		
eee		0.05		



256-Ball ftBGA Package Option 1: ispMACH 4000, MachXO, LatticeXP2

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

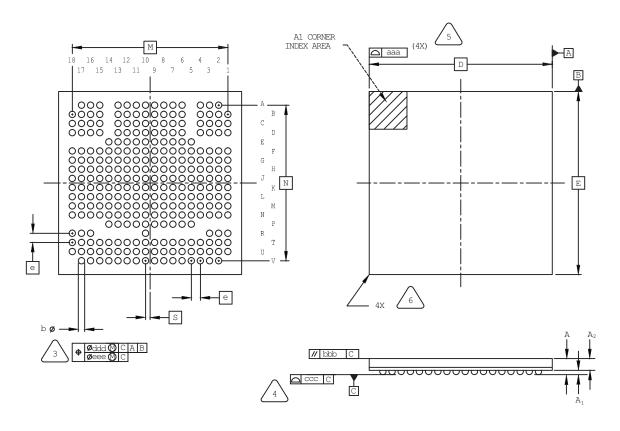


SYMBOL	MIN.	NOM.	MAX.
А	1.25	1.40	1.55
A1	0.30	-	-
A2	-	-	1.25
D/E	1	7.0 BSC	
M/N	15.0 BSC		
S	0.50 BSC		
b	0.40	0.50	0.60
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.12



285-Ball csfBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C].



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

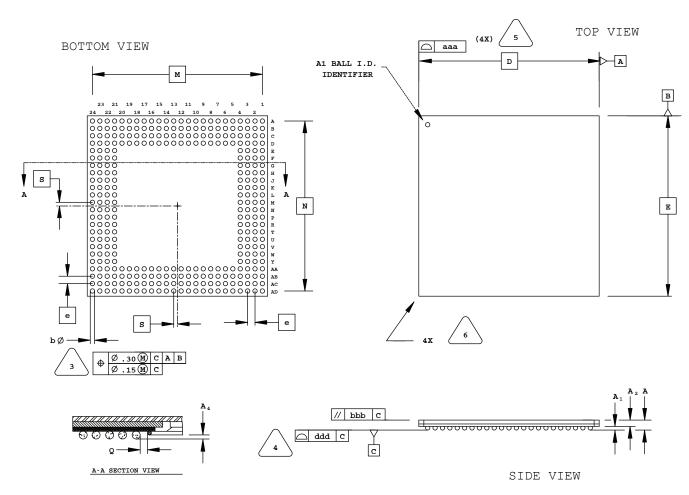


SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.30
A1	0.15	_	_
A2	-	-	1.00
D/E	10.00 BSC		
M/N	8.50 BSC		
S	0.25 BSC		
b	0.25 0.30 0.35		
е	0.50 BSC		
aaa	0.10		
bbb	0.10		
ccc	0.08		
ddd	0.15		
eee	0.05		



320-Ball SBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES
 PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

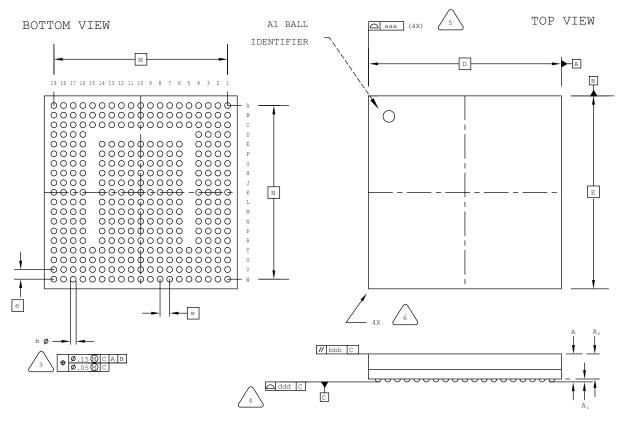


SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.70
A1	0.50	0.65	0.80
A2	0.80	0.90	1.00
D/E	3:	1.00 BSC	
M/N	29.21 BSC		
s	0.635 BSC		
b	0.60	0.75	0.90
е	1.27 BSC		
Q	0.25	-	-
A4	0.10	-	-
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.20



328-Ball csBGA Package

Dimensions in Millimeters



SIDE VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

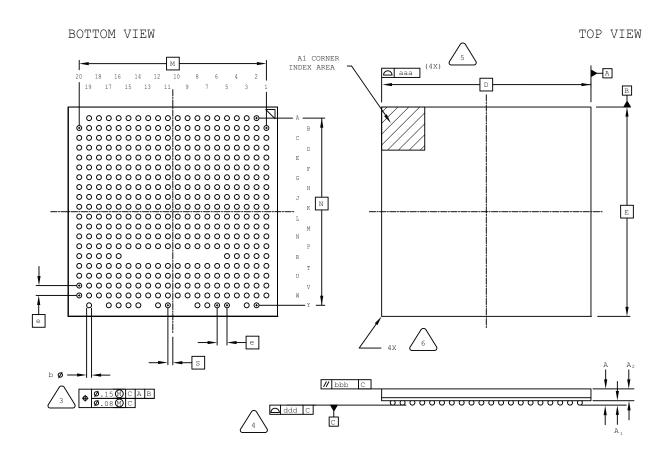


SYMBOL	MIN.	NOM.	MAX.
А	1.05	1.35	1.50
A1	0.15	_	_
A2	_	_	1.20
D/E	10.0 BSC		
M/N	9.00 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	_	-	0.10
bbb	-	-	0.10
ddd	_	_	0.08



381-Ball caBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

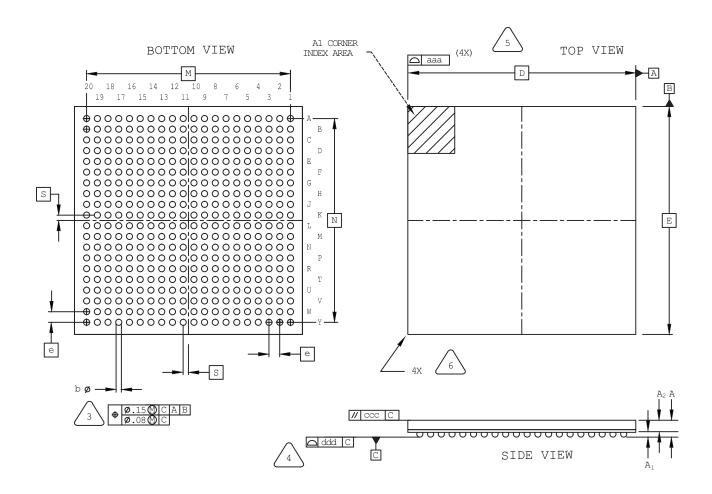


SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.76
A1	0.25	0.30	0.35
A2	0.80	-	ı
D/E	17.00 BSC		
M/N	15.20 BSC		
S	0.40 BSC		
b	0.35	0.40	0.45
е	0.80 BSC		
aaa	_	-	0.15
bbb	-	-	0.20
ddd	-	_	0.12



400-Ball caBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM $\boxed{\mathbb{C}}$



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

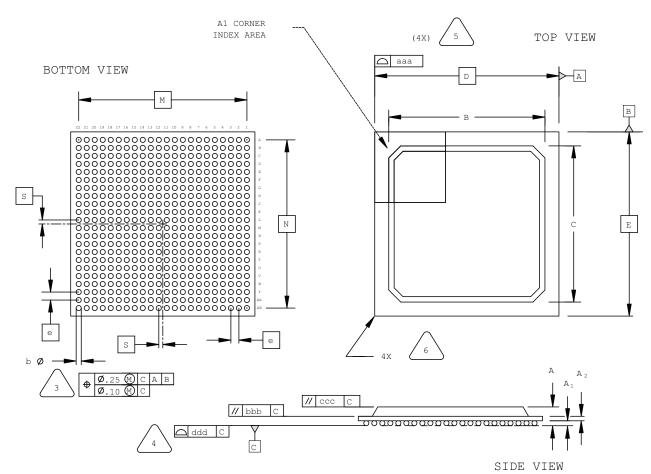


SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.70
A1	0.25	0.35	-
A2	0.80	1.00	_
D/E	1	7.0 BSC	
M/N	15.2 BSC		
S	0.40 BSC		
b	0.40	0.45	0.50
е	0.80 BSC		
aaa	_	_	0.15
ccc	_	_	0.20
ddd	_	_	0.20



484-Ball fpBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM $\fbox{\colored{C}}$



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

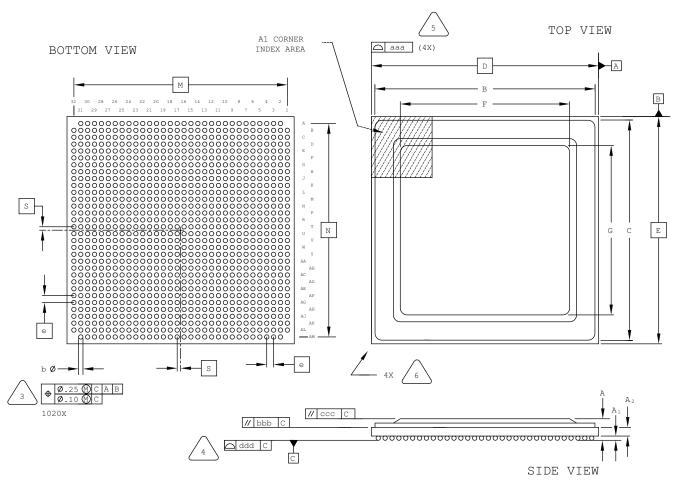


SYMBOL	MIN.	NOM.	MAX.
A	1.70	2.15	2.60
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	19.30	19.80	20.30
D/E	23.00 BSC		
M/N	21.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	_	_	0.20
bbb	_	_	0.25
ccc	_	_	0.35
ddd	_	_	0.20



1020-Ball Organic fcBGA Package Rev. 2

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

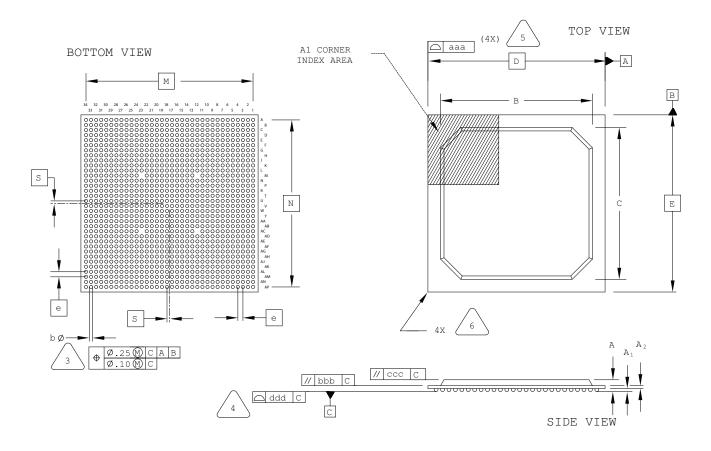


SYMBOL MIN. NOM. MAX. A 2.55 2.90 3.25 A1 0.40 0.50 0.60 A2 1.20 REF B/C 32.40 32.60 32.80 D/E 33.00 BSC F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC aaa - 0.20				
A1 0.40 0.50 0.60 A2 1.20 REF B/C 32.40 32.60 32.80 D/E 33.00 BSC F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	SYMBOL	MIN.	NOM.	MAX.
A2 1.20 REF B/C 32.40 32.60 32.80 D/E 33.00 BSC F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	A	2.55	2.90	3.25
B/C 32.40 32.60 32.80 D/E 33.00 BSC F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	A1	0.40	0.50	0.60
D/E 33.00 BSC F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	A2	1	.20 REF	
F/G 24.50 24.60 24.70 M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	B/C	32.40	32.60	32.80
M/N 31.00 BSC S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	D/E	3:	3.00 BSC	
S 0.50 BSC b 0.50 0.60 0.70 e 1.00 BSC	F/G	24.50	24.60	24.70
b 0.50 0.60 0.70 e 1.00 BSC	M/N	31.00 BSC		
e 1.00 BSC	S	0.50 BSC		
	b	0.50	0.60	0.70
aaa 0.20	е	1.00 BSC		
	aaa	-	-	0.20
bbb - 0.25	bbb	-	-	0.25
ccc 0.35	ccc	-	-	0.35
ddd 0.20	ddd	-	-	0.20



1152-Ball fpBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

Note: Depopulated ball locations are M12, M23, AC12, and AC23.

SYMBOL	MIN.	NOM.	MAX.
А	1.90	2.25	2.60
A1	0.30	0.50	0.70
A2	0.40	0.60	0.80
B/C	29.80	30.30	30.80
D/E	3.	5.00 BSC	
M/N	33.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	_	_	0.20
bbb	_	_	0.25
ccc	-	-	0.35
ddd	_	_	0.20